

MICTOR

TE Internal #: 2-1658043-1 PCB Mount Receptacle, Vertical, Board-to-Board, 40 Position, .8 mm [.031 in] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal

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PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **40**

Centerline (Pitch): .8 mm [.031 in]

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Receptacle

Board-to-Board

Fully Shrouded



Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	40
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	675 VAC
Insulation Resistance	2 MΩ
Impedance	100 Ω
Operating Voltage	125 VAC
Body Features	
Assembly Process Feature Material	Polyimide Film

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Primary Product Color	Black
Contact Features	
Mating Tab Width	.38 mm[.015 in]
Mating Tab Thickness	.2 mm[.008 in]
Contact Shape & Form	Single Beam
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold Flash
Contact Mating Area Plating Material Thickness	.12 μm[5 μin]
Contact Type	Socket
Contact Current Rating (Max)	1.25 A, 9.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.15 mm[.006 in]
Rectangular Termination Post & Tail Width	1.77 mm[.07 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Retention	With
Mating Alignment	Without
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Connector Height	3.05 mm[.12 in]
Stack Height	5 mm, 8 mm, 11 mm, 16 mm, 19 mm, 22 mm, 25 mm, 30 mm[1.181 in]
PCB Thickness (Recommended)	.05 mm[.12 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]

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Operation/Application

Assembly Process Feature	Pick and Place Cover			
Circuit Application	Power & Signal			
Industry Standards				
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	96			
Packaging Method	Box, Tray			
Product Compliance				
For compliance documentation, visit the product page on TE.com>				

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240)	

Does not contain REACH SVHC

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Reflow solder capable to 260°C

Solder Process Capability

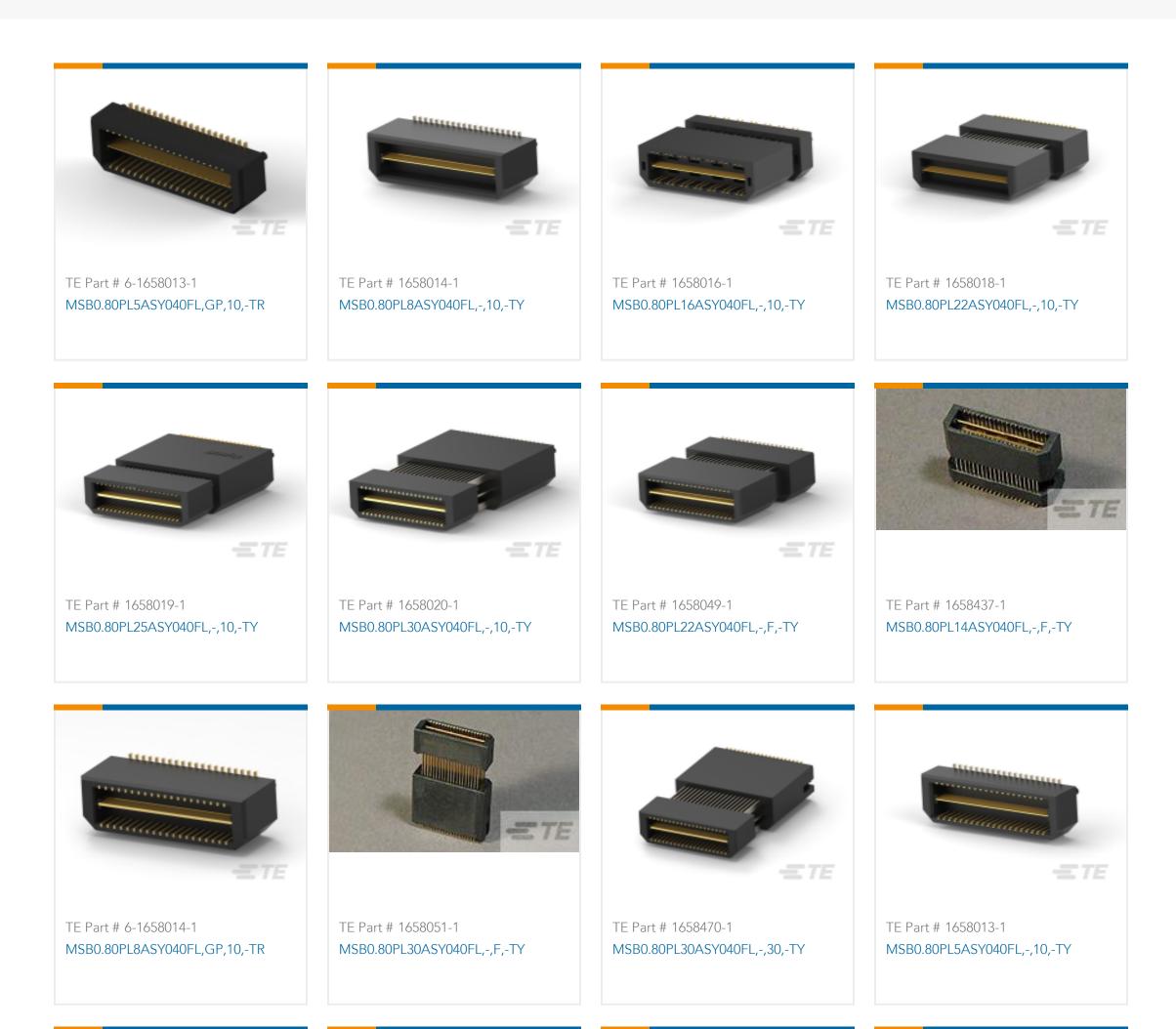
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

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	TE TE	ETE	
TE Part # 1658015-1	TE Part # 1658017-1	TE Part # 1658044-1	TE Part # 1658045-1
MSB0.80PL11ASY040FL,-,10,-TY	MSB0.80PL19ASY040FL,-,10,-TY	MSB0.80PL5ASY040FL,-,F,-TY	MSB0.80PL8ASY040FL,-,F,-TY
		ETE	
TE Part # 1658046-1	TE Part # 1658047-1	TE Part # 1658048-1	TE Part # 1658050-1
MSB0.80PL11ASY040FL,-,F,-TY	MSB0.80PL16ASY040FL,-,F,-TY	MSB0.80PL19ASY040FL,-,F,-TY	MSB0.80PL25ASY040FL,-,F,-TY

Customers Also Bought

PCB Mount Receptacle, Vertical, Board-to-Board, 40 Position, .8 mm [.031 in] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal





Documents

Product Drawings MSB0.80RC-ASY040FL,-,F,-TY

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-1658043-1_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-1658043-1_L.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-1658043-1_L.3d_stp.zip

English

By downloading the CAD file I accept and agree to the $\ensuremath{\text{Terms}}$ and $\ensuremath{\text{Conditions}}$ of use.

Datasheets & Catalog Pages MICTOR SB Interconnection System

English

Product Specifications Application Specification

English